

PRODUCT SPECIFICATION

PART NUMBER #REV: FLD-156MML50PCSA2#00

DESCRIPTION: TFT 15.6''W 1920*1080 Full View LVDS 1000CD + Led Cable
assembled with Rocktouch Pcap Black USB / I2C

- () Preliminary Specification
(V) Approved Specification

Customer Name:	
Signature:	Date:

PREPARED BY	REVIEWED BY
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Revision History

Spec Version	Date	Page	Description	Note
V1.0	2021/02/12		First Edition	

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1. GENERAL DESCRIPTION

1.1 Description

15.6" is a Color Active Matrix Liquid Crystal Display Module composed of a TFT LCD panel and LED backlight system. The screen format is intended to support the FHD, 1920x1080 screen and 16.2M colors.

1.2 Product Summary

The following items are summary on the table under Ta=25 °C condition:

No.	Item	Specification	Unit
1	Display Size	15.6w	Inch
2	Pixel Number	1920 (H) x 3(RGB)x 1080 (V)	Pixels
3	Outline Dimension	424(H) x 273(V) x 13.75(T)	mm
4	Active Area	344.16(H) X 193.59(V)	mm
5	Display Colors	16.2M	--
6	Pixel Arrangement	RGB vertical stripe	--
7	Display Mode	Full View / Normally Black	--
8	Electrical Interface	LVDS	--
9	Surface Treatment	Anti-Glare, 3H hard coating	--
10	Brightness	1000 (Typ.)	cd/m ²
11	Contrast Ratio	800 (Typ.)	--
12	Total Power Consumption (Typ)	16 W (VDD line= 4 W; LED lines= 12 W)	W

2. ABSOLUTE MAXIMUM RATING

2.1 Electrical Absolute Rating

Item	Symbol	Values			Unit	Note
		Min	Typ	Max		
Power supply voltage	VCC	-0.3	-	4.0	V	(1)
Logic Input Voltage	VIN	-0.3	-	4.0	V	
LED Current	I LED	--	600	--	mA / Channel	Duty=100% (1)(2)

Note (1) Permanent damage to the device may occur if max values are exceeded.

Function operation should be restricted to the conditions described under normal operating conditions.

(2) Specified values are for input pin of LED light bar at $T_a = 25 \pm 2^\circ C$

2.2 Environment Absolute Rating

Item	Symbol	Values			Unit	Note
		Min	Typ	Max.		
Operating Temperature	Top	-30		85	°C	
Storage Temperature	Tstg	-40		90	°C	Note(1)(2)

Note (1) : Max O.T. LCD surface Temperature

Note(2) : Permanent damage to the device may occur if exceed maximum values

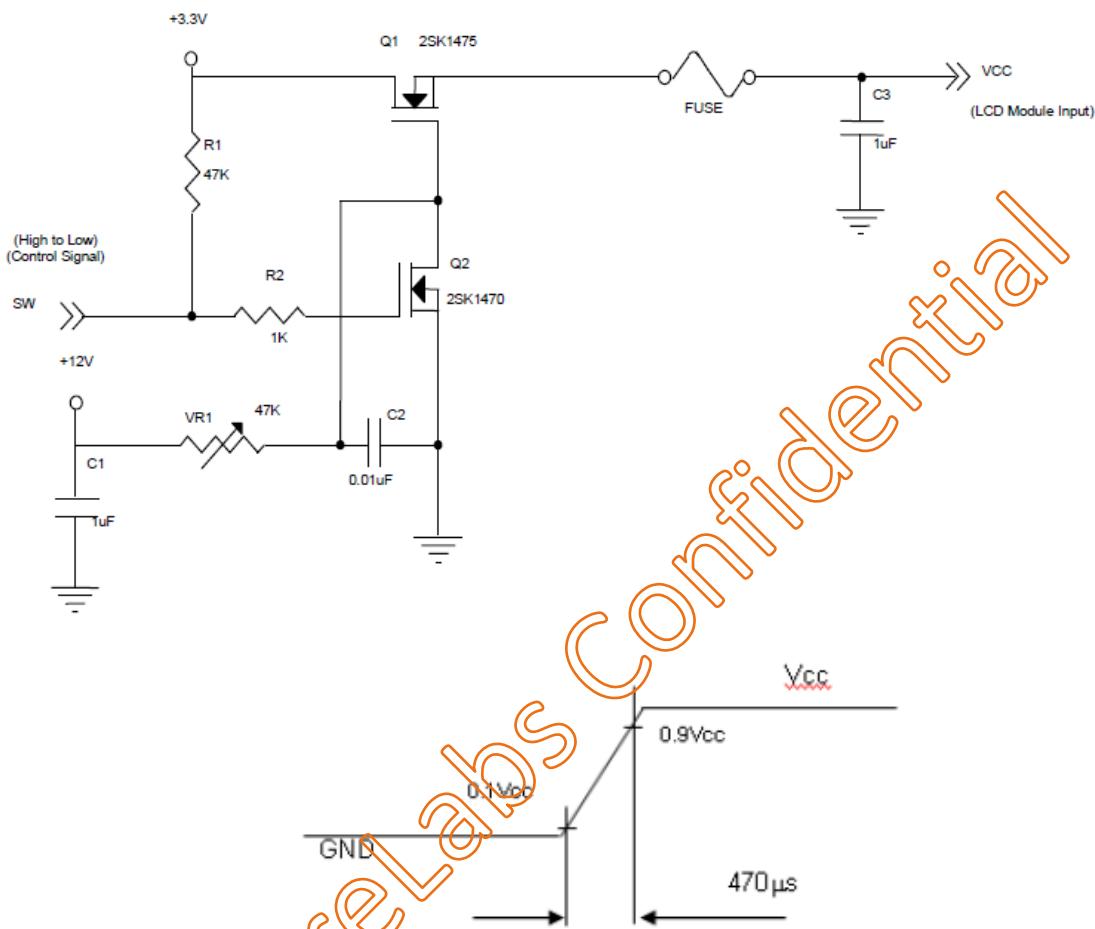
3. ELECTRICAL CHARACTERISTICS

3.1 LCM

Parameter	Symbol	Value			Unit	Note
		Min.	Typ.	Max.		
Power Supply Voltage	VCC	3.0	3.3	3.6	V	
Ripple Voltage	VRP	--	--	150	mV	
Rush Current	IRUSH	--	--	3.0	A	(2)
Power Supply Current	White	--	1.22	1.5	A	(3)
	Black	--	0.51	0.7	A	
	Vertical Stripe	--	0.82	1	A	
Power Consumption	PLC	--	4	5	W	
LVDS differential input voltage	Vid	200	--	600	mV	(4)
LVDS common input voltage	Vic	1.0	1.2	1.4	V	(4)
Terminating Resistor	RT		100		Ohm	

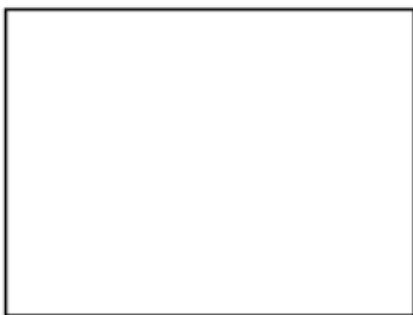
Note (1) The assembly should be always operated within above ranges. $T_a = 25 \pm 2^\circ C$

Note (2) Measurement Conditions:



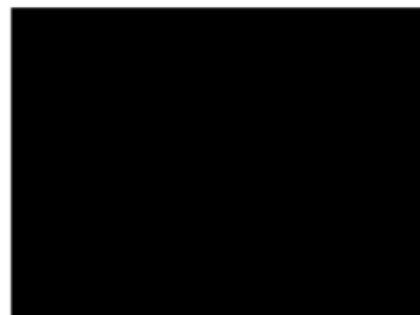
Note (3) The specified power supply current is under the conditions at $V_{CC}=3.3V$, $f_r=60Hz$, whereas a power dissipation check pattern below is displayed

a. White Pattern⁽⁴⁾



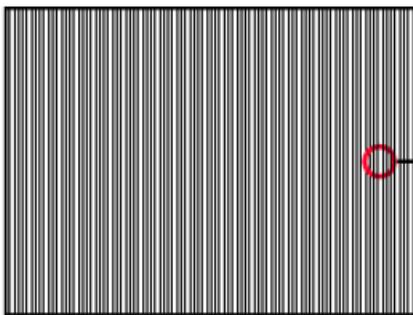
Active Area⁽⁵⁾

b. Black Pattern⁽⁴⁾



Active Area⁽⁵⁾

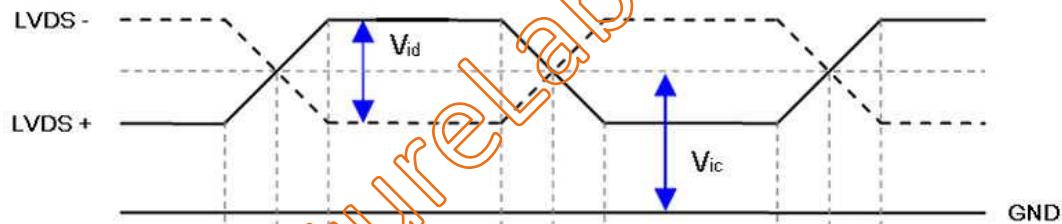
c. Vertical Stripe Pattern⁽⁴⁾



Active Area⁽⁵⁾

Note (4) The power consumption is specified at the pattern with the maximum current.

Note (5) VID waveform condition.



3.2 Backlight Unit

Parameter guideline for LED driving is under stable conditions at 25°C (Room Temperature):

Parameter	Min.	Typ.	Max.	Unit	Note
LED voltage (VL)		39			V
LED current (IL-channel)		300			mA
LED Power (PL)		11,7			W
LED life Time (Typical)	--	100,000	--	Hrs	(2) (1)

Note 1: The “LED lift time” is defined as the module brightness decrease to 50% original brightness that the ambient temperature is 25°C and typical LED Current at 300 mA/channel.

Note 2: PL=VL x IL

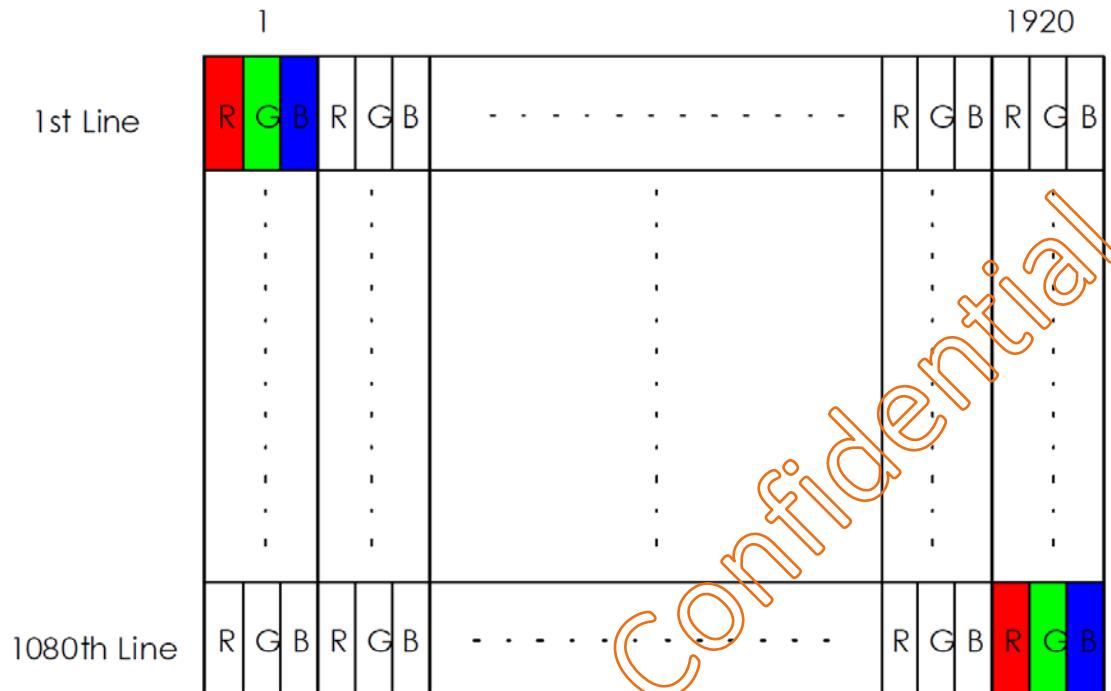
LED Bar Connector: JOIN TEK JT1025-1021 (BHSR-07VS-1)

Pin no	Symbol	I/O	Description	Remark
1	VLED+	P	Backlight LED anode	Red
2	VLED-	P	Backlight LED cathode	Black

3.3 Signal Interface Characteristic

1. Pixel Format Image

Following figure shows the relationship of the input signals and LCD pixel format.



2. Scanning Direction

The following figures show the image seen from the front view. The arrow indicates the direction of scan.

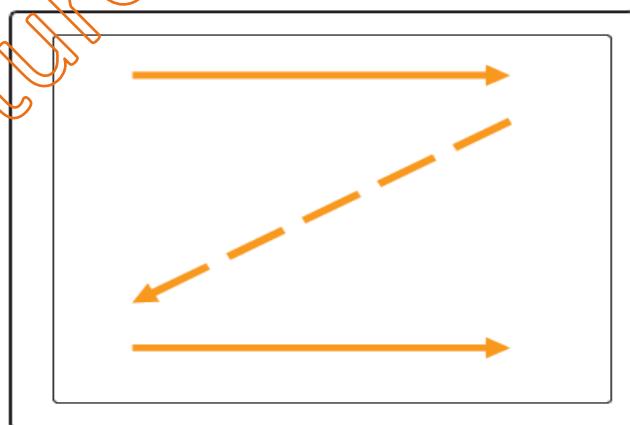


Fig. 1 Normal scan (Pin4, DPS = Low or NC)

4. SIGNAL CHARACTERISTICS

4.1 Interface Timing

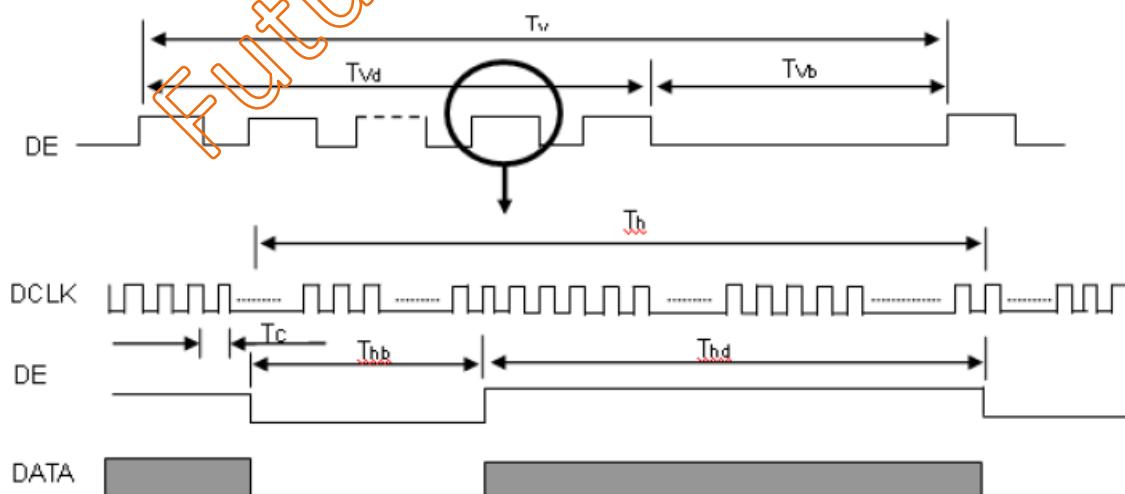
4.1.1 Timing Characteristics:

Signal	Item	Symbol	Min.	Typ.	Max.	Unit	Note
LVDS Clock	Frequency	F _c	60	70.93	75	MHZ	
	Period	T _c	--	14.1	--	ns	
	Input cycle to cycle jitter	T _{rd}	-0.02*T _c	--	0.02*T _c	ns	(3)
	Input Clock to data skew	T _{LVCCS}	-0.02*T _c	--	0.02*T _c	ps	(4)
	Spread spectrum modulation range	F _{clkin_mod}	F _c *98%	--	F _c *102%	MHz	(5)
	Spread spectrum modulation frequency	F _{SSM}	--	--	200	KHz	
Vertical Display Term	Frame Rate	F _r	50	60	60	Hz	T _v =T _{vd} +T _{vb}
	Total	T _v	1090	1110	1130	Th	--
	Display	T _{vd}	1080	1080	1080	Th	--
	Blank	T _{vb}	T _v -T _{vd}	30	T _v -T _{vd}	Th	--
Horizontal Display Term	Total	T _h	1050	1065	1075	T _c	T _h =T _{hd} +T _{hb}
	Display	T _{hd}	960	960	960	T _c	--
	Blank	T _{hb}	T _h -T _{hd}	105	T _h -T _{hd}	T _c	--

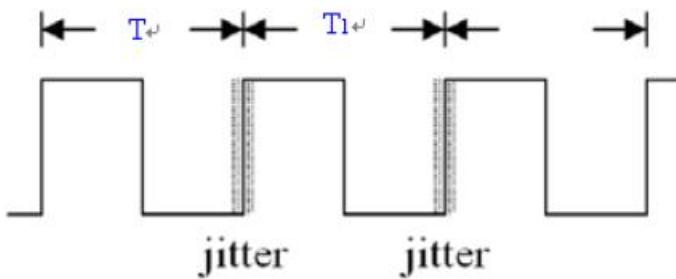
Note (1) Because this module is operated by DE only mode, Hsync and Vsync input signals are ignored.

Note (2) The T_v(T_{vd}+T_{vb}) must be integer, otherwise this module would operate abnormally.

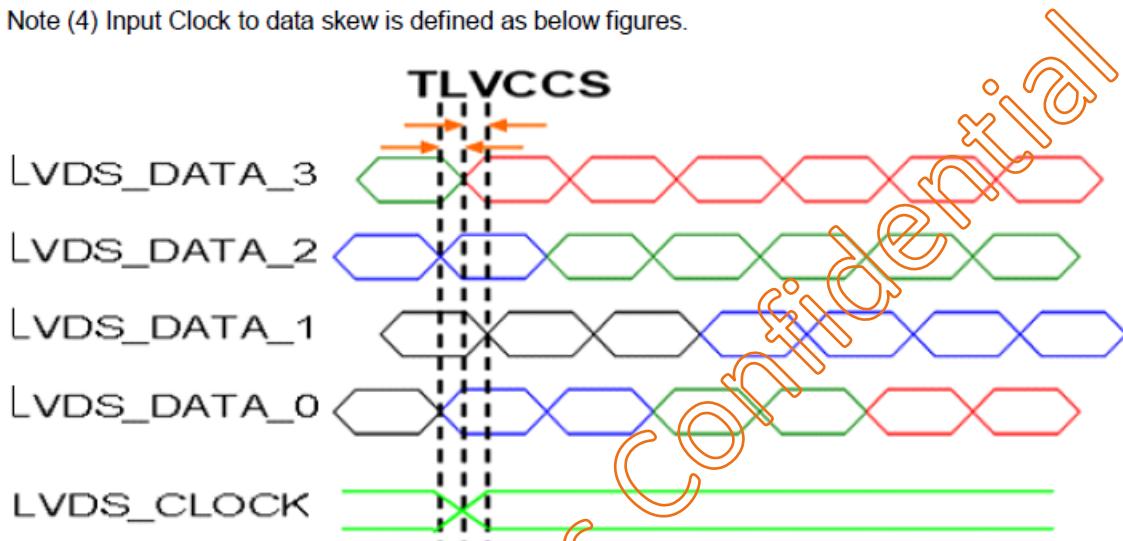
INPUT SIGNAL TIMING DIAGRAM



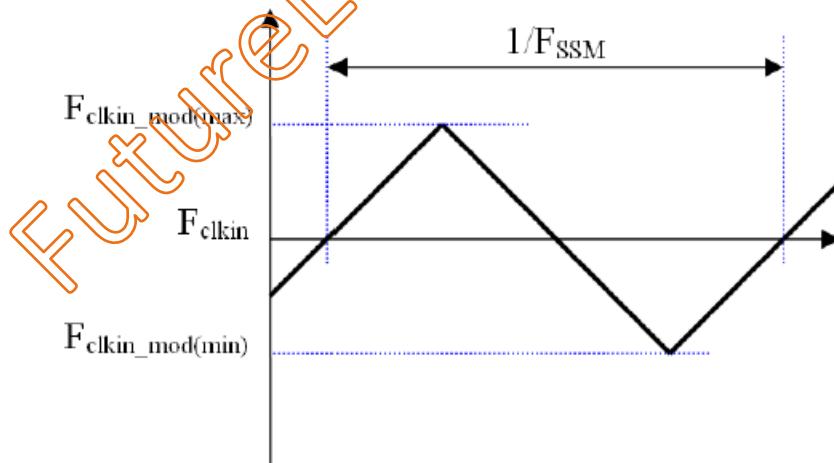
Note (3) The input clock cycle-to-cycle jitter is defined as below figures. $T_{rcl} = |T_1 - T|$



Note (4) Input Clock to data skew is defined as below figures.

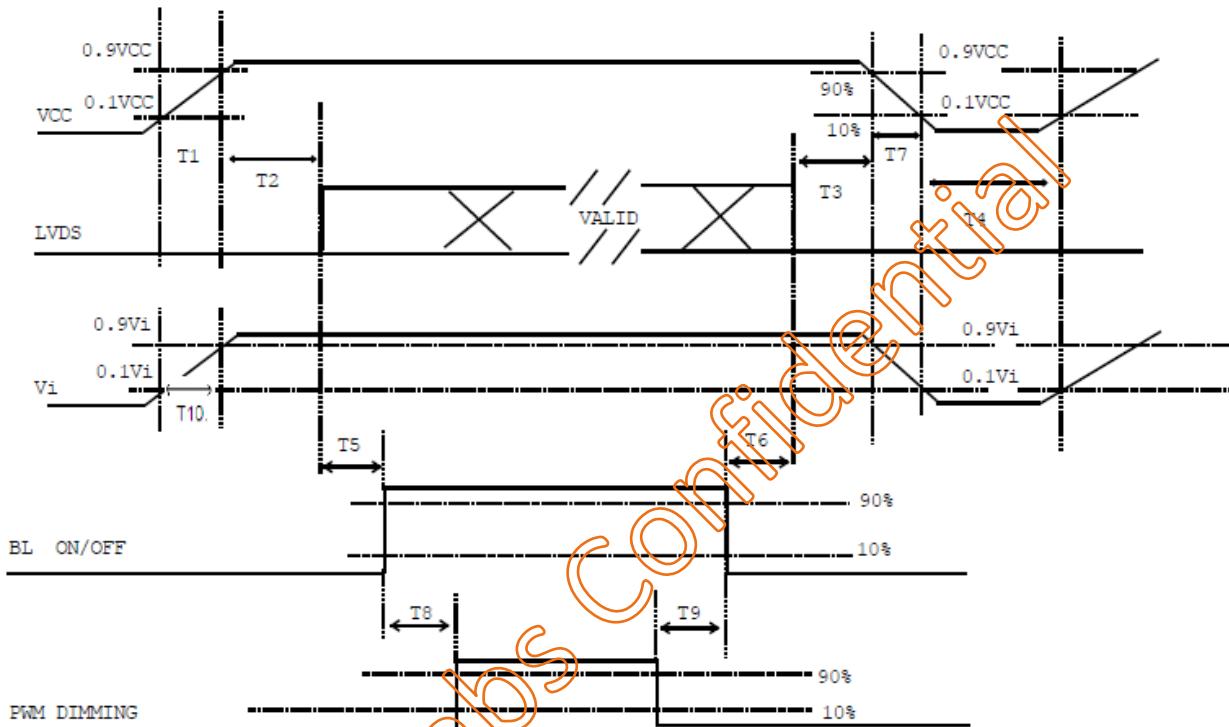


Note (5) The SSCG (Spread spectrum clock generator) is defined as below figures.



4.1.2 Power ON/OFF Sequence

To prevent a latch-up or DC operation of LCD assembly, the power on/off sequence should be as the diagram below.



Timing specifications:

Parameter	Value			Units
	Min	Typ	Max	
T1	0.5	-	10	ms
T2	0	-	50	ms
T3	0	-	50	ms
T4	500	-		ms
T5	450	-		ms
T6	20	-		ms
T7	10	-	300	ms
T8	10	-		ms
T9	10	-		ms
T10	20	-		ms

Note (1) Please avoid floating state of interface signal at invalid period.

Note (2) When the interface signal is invalid, be sure to pull down the power supply of LCD VCC to 0V.

Note (3) The Backlight converter power must be turned on after the power supply for the logic and the interface



signal is valid.

The Backlight converter power must be turned off before the power supply for the logic and the interface signal is invalid.

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5. INTERFACE PIN DESCRIPTION

5.1 LCM Connector PIN Assignment

NO	Symbol	Description	Note
1	NC	Not connection, this pin should be open	-
2	NC	Not connection, this pin should be open	-
3	NC	Not connection, this pin should be open	-
4	NC	Not connection, this pin should be open	-
5	GND	Ground	-
6	GND	Ground	-
7	GND	Ground	-
8	GND	Ground	-
9	NC	Not connection, this pin should be open	-
10	NC	Not connection, this pin should be open	-
11	LCD_Vcc	LCD logic and driver power 3.3V	
12	LCD_Vcc	LCD logic and driver power 3.3V	
13	LCD_Vcc	LCD logic and driver power 3.3V	
14	NC	No connection	-
15	NC	No connection	-
16	NC	No connection	-
17	REV SCAN	Low or NC - Normal Mode. High- Horizontal & Vertical Reverse Scan	Note (3)
18	RXO0-	Negative LVDS differential data input. CHO0(odd)	-
19	RXO0+	Positive LVDS differential data input. CHO0(odd)	-
20	RXO1-	Negative LVDS differential data input. CHO1(odd)	
21	RXO1+	Positive LVDS differential data input. CHO1(odd)	
22	RXO2-	Negative LVDS differential data input. CHO2(odd)	
23	RXO2+	Positive LVDS differential data input. CHO2(odd)	
24	LCD GND	LCD logic and driver ground	

25	RXOC-	Negative LVDS differential clock input (odd)	
26	RXOC+	Positive LVDS differential clock input (odd)	
27	LCD GND	LCD logic and driver ground	
28	RXO3-	Negative LVDS differential data input. CHO3(odd)	
29	RXO3+	Positive LVDS differential data input. CHO3(odd)	
30	RXE0-	Negative LVDS differential data input. CHE0 (even)	
31	RXE0+	Positive LVDS differential data input. CHE0 (even)	
32	RXE1-	Negative LVDS differential data input. CHE1 (even)	
33	RXE1+	Positive LVDS differential data input. CHE1 (even)	
34	LCD GND	LCD logic and driver ground	
35	RXE2-	Negative LVDS differential data input. CHE2 (even)	
36	RXE2+	Positive LVDS differential data input. CHE2 (even)	
37	RXEC-	Negative LVDS differential clock input (even)	
38	RXEC+	Positive LVDS differential clock input (even)	
39	RXE3-	Negative LVDS differential data input. CHE3 (even)	
40	RXE3+	Positive LVDS differential data input. CHE3 (even)	

Note (1) Connector Part no.: I-PEX 20455-040E-76 or equivalent.

Note (2) User's connector Part no. I-PEX 20453-040T-03 or equivalent.

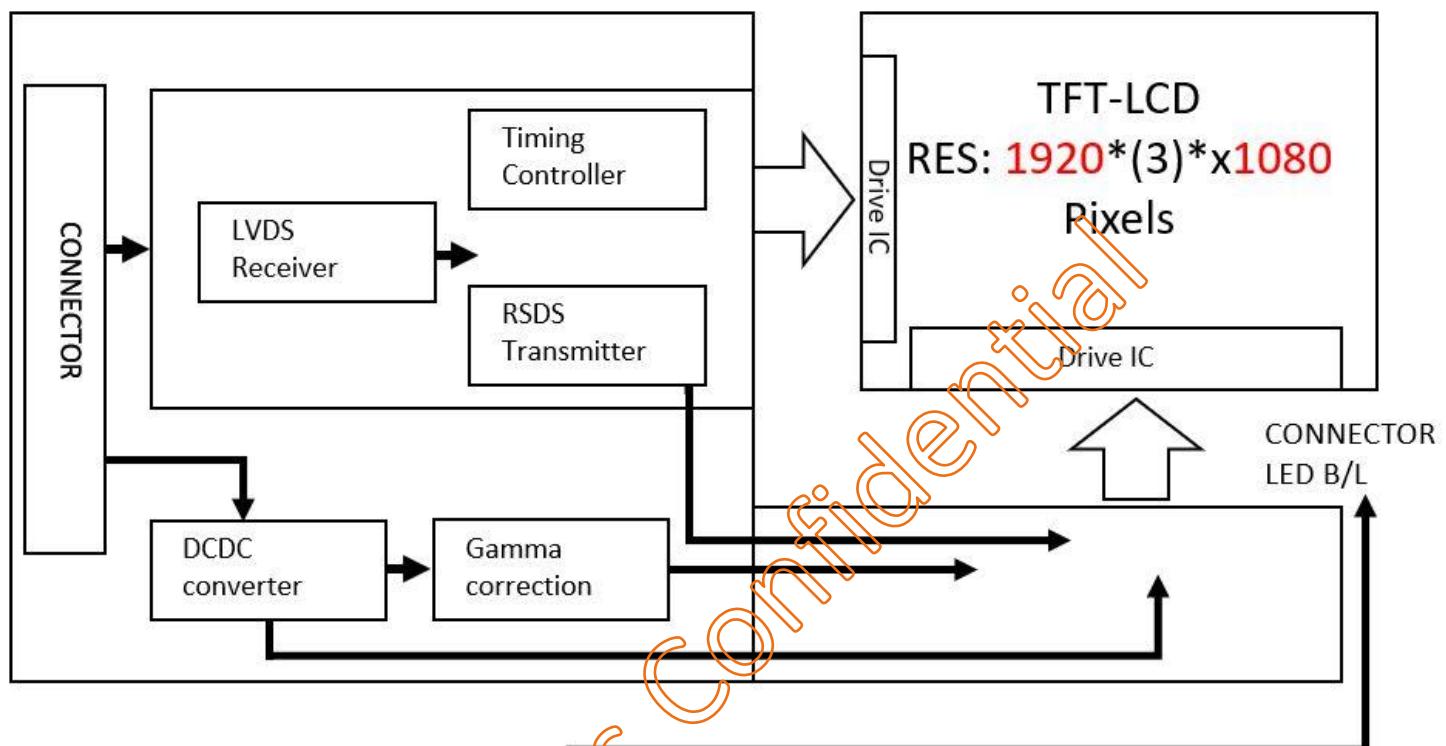
Note (3) "Low" stands for 0V. "High" stands for 3.3V. "NC" stands for "No Connected".

5.2 LVDS DATA MAPPING TABLE

LVDS Channel O0	LVDS output	D7	D6	D4	D3	D2	D1	D0
	Data order	OG0	OR5	OR4	OR3	OR2	OR1	OR0
LVDS Channel O1	LVDS output	D18	D15	D14	D13	D12	D9	D8
	Data order	OB1	OB0	OG5	OG4	OG3	OG2	OG1
LVDS Channel O2	LVDS output	D26	D25	D24	D22	D21	D20	D19
	Data order	DE	NA	NA	OB5	OB4	OB3	OB2
LVDS Channel O3	LVDS output	D23	D17	D16	D11	D10	D5	D27
	Data order	NA	OB7	OB6	OG7	OG6	OR7	OR6
LVDS Channel E0	LVDS output	D7	D6	D4	D3	D2	D1	D0
	Data order	EG0	ER5	ER4	ER3	ER2	ER1	ER0
LVDS Channel E1	LVDS output	D18	D15	D14	D13	D12	D9	D8
	Data order	EB1	EB0	EG5	EG4	EG3	EG2	EG1
LVDS Channel E2	LVDS output	D26	D25	D24	D22	D21	D20	D19
	Data order	DE	NA	NA	EB5	EB4	EB3	EB2
LVDS Channel E3	LVDS output	D23	D17	D16	D11	D10	D5	D27
	Data order	NA	EB7	EB6	EG7	EG6	ER7	ER6

6. BLOCK DIAGRAM

The following diagram shows the functional block of the TFT module:



7. OPTICAL CHARACTERISTIC

The optical characteristics are measured under stable conditions at room temperature.

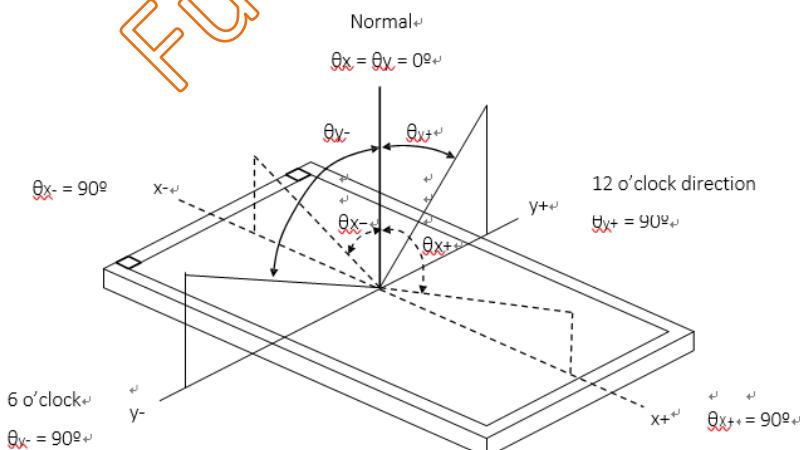
Item	Symbol	Condition	Min.	Typ.	Max.	Unit	Note		
Contrast Ratio	CR	$\theta_x=0^\circ, \theta_y=0^\circ$ Viewing angle at normal direction	600	800	-	-	(2)(5)		
Response Time	TR		-	13	-	ms	(3)		
	TF		-	12	-	ms			
Center Luminance of White	LC		800	1000	-	cd/m ²	(4)(5)		
White Variation	δW		70	75	--	%	(5)(6)		
Chromaticity	Red Rx		0.652	Typ.	+0.05	-	(1)		
	Red Ry		0.338						
	Green Gx		0.333						
	Green Gy		0.613						
	Blue Bx		0.150						
	Blue By		0.050	-0.05			(5)		
	White Wx		0.313						
	White Wy		0.329						
	Horizontal θ_{x+}		80	CR≥10	85	-	Deg. (1)(5)		
	Horizontal θ_{x-}		80						
	Vertical θ_{y+}		80						
	Vertical θ_{y-}		80						

The following optical specifications shall be measured in a darkroom or equivalent state (ambient luminance <2 lux, and at room temperature).

The room temperature is 25°C±2°C.

Note 1: Definition of Viewing Angle

Viewing angle is the angle at which the contrast ratio is greater than 10. The viewing angles are determined for the horizontal or the vertical clock direction with respect to the optical axis which is normal to the LCD surface

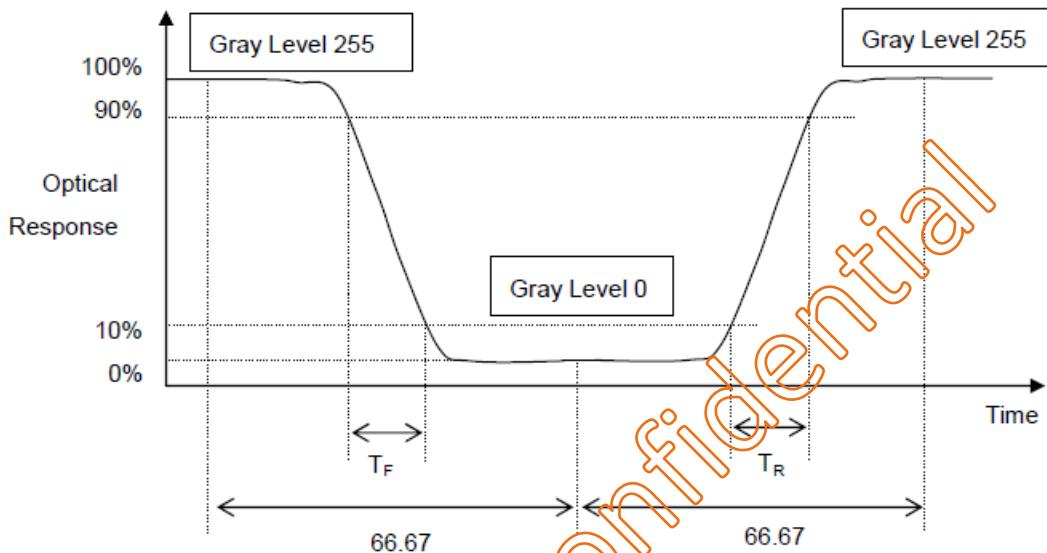


Note 2: Definition of Contrast Ratio (CR)

Measure the viewing angle of $\Theta=0$ and at the center of the LCD surface. Luminance with all pixels in white state divide by Luminance with all pixels in Black state

Note 3 Definition of Response Time:

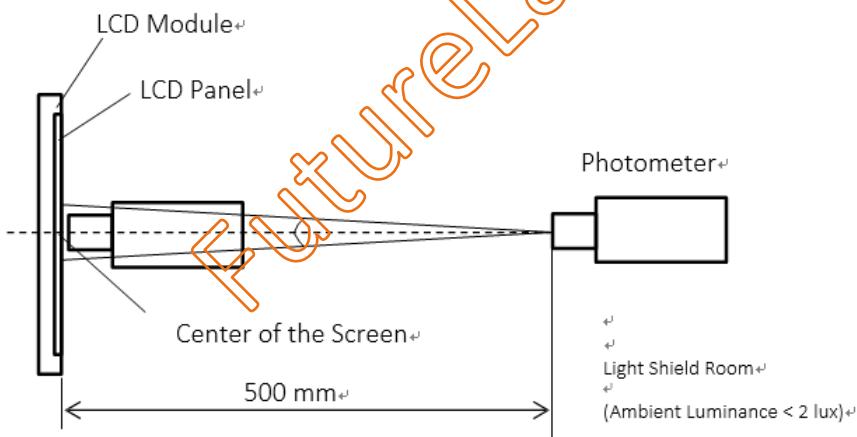
The response time is set initially by defining the “Rising Time (T_R)” and the “Falling Time (T_F)” respectively. Please refer the figure to the followings:



Note 4: Definition of Brightness (L)

Measure the center area of the panel and the viewing angle of the $\theta_x=\theta_y=0^\circ$

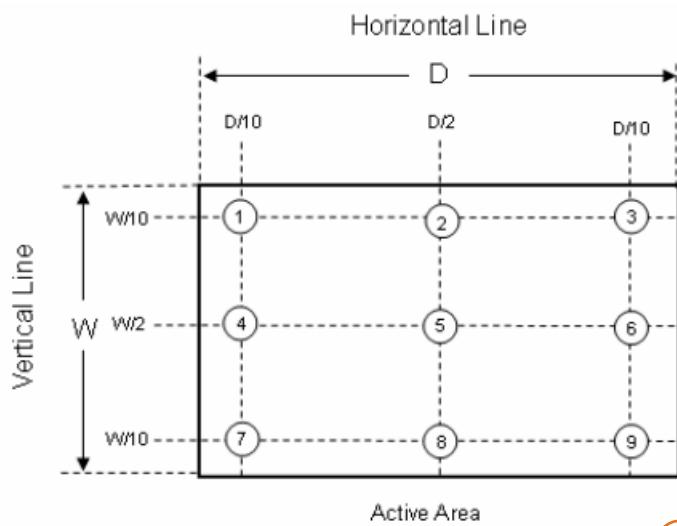
Note 5: The method of optical measurement:



Note 6: Definition of White Variation (δW):

Measure the luminance of gray level 255 at 5 points

$$\delta W = \frac{\text{Maximum} [L(1), L(2), L(3), L(4) \sim L(9)]}{\text{Minimum} [L(1), L(2), L(3), L(4) \sim L(9)]}$$



B. Touch Screen specification

1. Environmental Specification

Specification	Value	Remarks
Operating Temperature	-20°C ~ 70°C	
Storage Temperature	-40°C ~ 80°C	
Operating Humidity	20% ~ 90%RH	
Storage Humidity	10% ~ 90%RH	

2. Mechanical Specification

Specification	Value
Operating Life (Finger input)	10 ⁷ times
Light Transmittance	>86% Min. (JIS K-7105) with glass
Surface hardness	Depending by the cover Lens Material Customer choose
FPC Peeling Force	5N Max

3. COMBO Type Controller USB / I2C

Parameters	Features
Circuit Board Dimension	Refer to drawings
Channels of Panel	Based on Sensor Design
Input Voltage	3.5V~5.5V Typical 5V for USB suggest to use 5V for I2C too
Linearity(Note 1)	Single Line drawing accuracy : Up to 1pt +/- 1mm offset /10mm
Interface	Single Touch (point) accuracy : Up to 1pt +/- 1mm USB: 2.0(Below) Full Speed I2C:100K/400K Hz
Resolution	4096x4096 resolution
Power consumption(mA)	Active Mode: <110mA Idle Mode : <55mA Sleep Mode :< 10mA (Operation Mode :Active Mode only)
Report rate(points/sec) Note(2)	> 100 Hz
Response time	Average < 25 ms

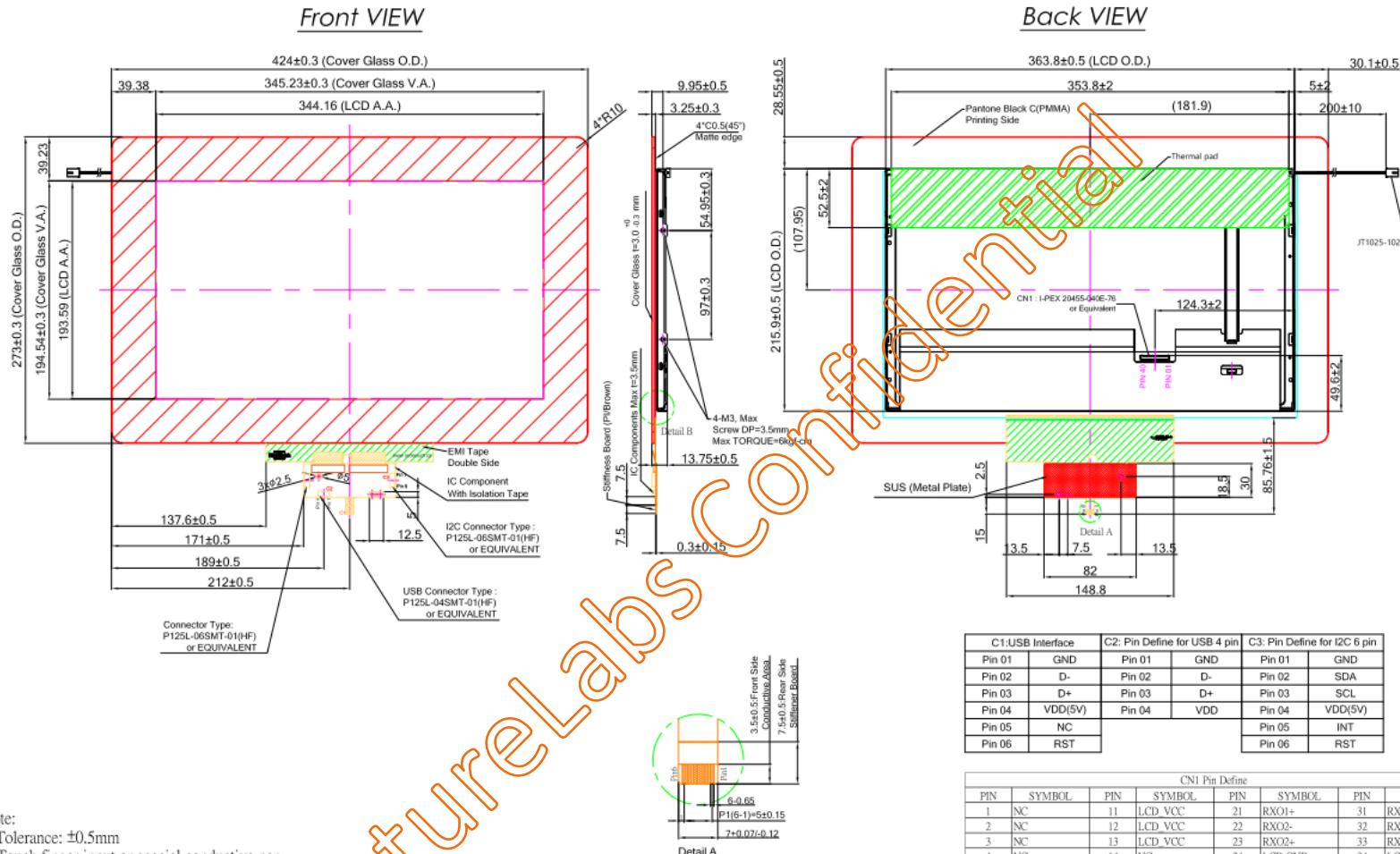


Note (1): Depending by Sensor design and other parameters, Refer to Windows 8 Logo regulation if need to follow min spec

Note (2): Report rate will vary by channel number, cover thickness, number of fingers and other parameters

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8. DIMENSION AND DRAWING



C1:USB Interface	C2: Pin Define for USB 4 pin	C3: Pin Define for I2C 6 pin
Pin 01 GND	Pin 01 GND	Pin 01 GND
Pin 02 D-	Pin 02 D-	Pin 02 SDA
Pin 03 D+	Pin 03 D+	Pin 03 SCL
Pin 04 VDD(5V)	Pin 04 VDD	Pin 04 VDD(5V)
Pin 05 NC		Pin 05 INT
Pin 06 RST		Pin 06 RST

CNI Pin Define							
PIN	SYMBOL	PIN	SYMBOL	PIN	SYMBOL	PIN	SYMBOL
1 NC		11 LCD VCC		21 RXO1+		31 RXE0+	
2 NC		12 LCD VCC		22 RXO2-		32 RXE1-	
3 NC		13 LCD VCC		23 RXO2+		33 RXE1+	
4 NC		14 NC		24 LCD GND		34 LCD GND	
5 GND		15 NC		25 RXOC-		35 RXE2-	
6 GND		16 NC		26 RXOC+		36 RXE2+	
7 GND		17 LCD GND		27 LCD GND		37 RXEC-	
8 GND		18 RXO0-		28 RXO3-		38 RXEC+	
9 NC		19 RXO0+		29 RXO3+		39 RXE3-	
10 NC		20 RXO1-		30 RXE0-		40 RXE3+	

Customer Approval		Part Number # Rev.		FLD-156MML50PCSA2 #00			
Date	Drawn By	Date	Person	Description			
Company							
Name							
Signature							
		Date	Design Rev Date	Check By	Date	Approved By	
		First Drawing 01/10/2022					

9. PRECAUTION AND PRODUCT HANDLING

- Do not apply the external force such as bending or twisting to the LCD panel and backlight during assembly.
- Do not insert and plug out the input connector while the LCD panel is operating.
- Do not take apart the panel or frame from LCD module assembly or insert anything into the backlight unit.
- Do not keep the same pattern in a long period of time, it may cause image sticking on LCD panel. Can use shuffle content periodically if fixed pattern is displayed on the screen.
- Do not touch the display area with bare hands, this will stain the display area.
- Pay attention to handle lead wire of backlight, that is not tugged in connect with LED driver.
- Do not change variable resistance settings in LCD panel, it may cause not satisfy of LCD characteristics specification.
- The surface of LCD panel's polarizer is very soft and easily scratched, please use a very soft dry cloth without chemicals for cleaning.
- To avoid the static electricity to damage the CMOS LSI, the operator should be grounded when in contact with the LCD panel, and also to all electrical equipment.
- Need to follow the correct power frequency when LCD panel is connecting and operating, this can avoid damage to CMOS LSI during latch-up.
- Need to store the LCD panel indoor without the exposure of sunlight where the temperature is $25^{\circ}\text{C} \pm 5^{\circ}\text{C}$ and the humidity is below 60% RH.